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Product Specification

Par	t Name	e:		OEL	Display	Module
\sim		_	T			

Customer Part ID:

Allvision Part ID:ZJY-2864KLBEG01

Ver: C

Customer:			
Approved by			

From: 中景园电子

Approved by

Notes:

- 1. Please contact Allvision technology Inc. before assigning your product based on this module specification
- 2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by Allvision technology Inc. for any intellectual property claims or other problems that may result from application based on the module described herein.

Revised History

Part Number	Revision	Revision Content	Revised on
QG-2864KLBEG01	Α	New	20130225
	В	RIREF=390K变更为 RIREF=910K	20130522
		亮度寄存器 (0X81) 参数 0XCF 变更为 0X66 亮度寄存器 (0X81) 参数 0X66 变更为 0XCF	
	С	寄存器(0xD9)的参数 0x1F 变更为 0xF1	20130529

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1. Basic Specifications

1.1 Display Specifications

Display Mode: Passive Matrix
 Display Color: Monochrome (Blue)

3) Drive Duty: 1/64 Duty

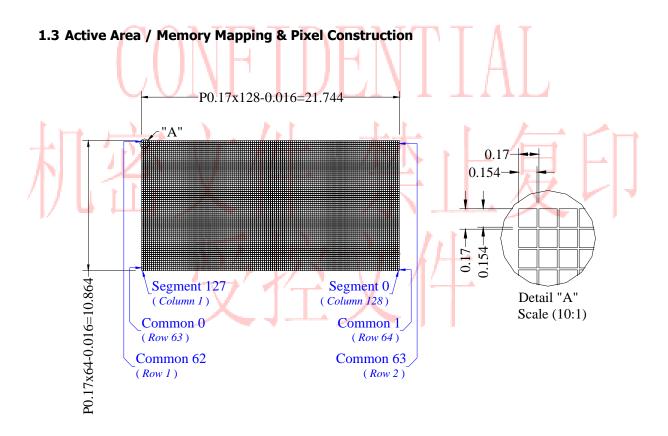
1.2 Mechanical Specifications

1) Outline Drawing: According to the annexed outline drawing

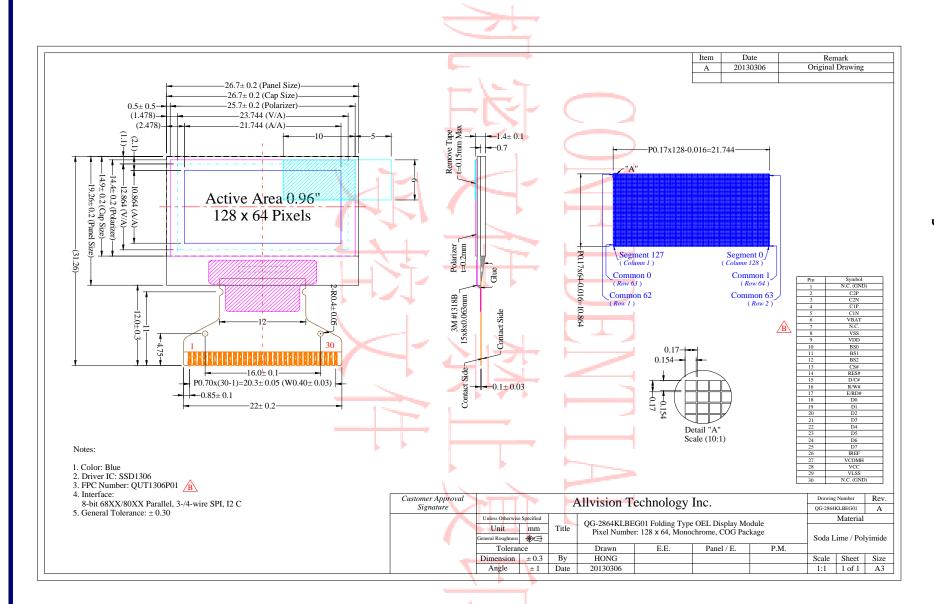
2) Number of Pixels: 128×64

3) Panel Size: $26.70 \times 19.26 \times 1.4 \text{ (mm)}$ 4) Active Area: $21.744 \times 10.864 \text{ (mm)}$ 5) Pixel Pitch: $0.17 \times 0.17 \text{ (mm)}$ 6) Pixel Size: $0.154 \times 0.154 \text{ (mm)}$

7) Weight: 1.54 (g)







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Pin Definition 1.5

Pin Number	Symbol	I/O	Function	
Power Suppl	y			
9	VDD	Р	Power Supply for Logic 逻辑电源这是一个电源引脚。 它必须连接到外部源。 This is a voltage supply pin. It must be connected to external source.	
8	VSS	Р	Ground of Logic Circuit 四舍五入逻辑电路这是一个接地引脚。 它用作逻辑引脚的参考。 它必须连接到外部接 This is a ground pin. It acts as a reference for the logic pins. It must be connected to external ground	
28	VCC	Р	Power Supply for OEL Panel 此引脚和VSS之间连接一个稳定电容器。不使用转换器时,必须将其接到外部。 This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and V _{SS} when the converter is used. It must be connected to external source when the converter is not used.	
29	VLSS	Р	Ground of Analog Circuit 模拟电路的接地这是一个模拟接地引脚。 它应该从外部连接到VSS。 This is an analog ground pin. It should be connected to V _{SS} externally.	
Driver				
26	IREF	I	Current Reference for Brightness Adjustment 该引脚是段电流参考引脚。 该引脚和VSS之 间应连接一 This pin is segment current reference pin. A resistor should be connected between this pin and V _{SS} . Set the current at 12.5μA maximum.	·个电阻
27	VCOMH	0	Voltage Output High Level for COM Signal 该引脚是COM信号的电压输出高电平的输入引脚	』VSS之间
DC/DC Conv	erter	4	DC / DC Converrtterr Ciirrcuiitt的电源供放器。这是D 电压转换器的内部缓冲器的电源引脚。	DC / DC
6	VBAT	Р	Power Supply for DC/DC Converter Circuit 应将其连接到VDD。 This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to external source when the converter is used. It should be connected to VDD when the converter is not used. 在FIIying Inverting Capritor	rmiinall
4/5 2/3	C1P / C1N C2P / C2N	ı	Positive Terminal of the Flying Inverting Capacitor 任刊 In Boost Capacitor 的 English	ive 使用转接
Interface	$ \vee$	-/-	induced when the converter is not used.	
		ш.	Communicating Protocol Select	
40	BC0	,	These pins are MCU interface selection input. See the following table: BS0 BS1 BS2	
10 11	BS0 BS1	A T	I ² C 0 1 0	
12	BS2	<u></u>	3-wire SPI 1 0 0	
12	552	1.	4-wire SPI 0 0 0 0 8-bit 68XX Parallel 0 0 1	
	V		8-bit 80XX Parallel 0 1 1	
14	RES#	I	Power Reset for Controller and Driver 该引脚为复位信号输入。当引脚为低电平时,执行芯;初始化。 This pin is reset signal input. When the pin is low, initialization of the chip is executed. Keep this pin pull high during normal operation.	在正常
13	CS#	I	Chip Select 该引脚是片选输入。 仅当CS#拉低时,才启用该芯片进行MCU通信。 This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.	
该引脚是数据/命	令控制引脚。 当引脚 入被视为显示数据。	被拉当	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at	
脚被拉低时,D7′ 存器。	DO的输入将被传送到		D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0	
当引脚被拉高 , SDIN处的数据	并且选择了串行接口 将被解释为数据。 将	模式时 其拉低	will be transferred to the command register.	
时,SDIN处的数。 在1 5 C模式下,	居将被传送到命令寄存 比引脚 的 作Cathy选择	⊦器。 ▼ 从机地	When the pin is pulled high and serial interface mode is selected, the data at SDIN will be interpreted as data. When it is pulled low, the data at SDIN will be	
有关与MCU接时序特性图。	口信号的详细关系,请	参考	transferred to the command register. In I ² C mode, this pin acts as SA0 for slave address selection. For detail relationship to MCU interface signals, please refer to the Timing	
该引脚为MCU接口输,时,此引脚将用作启高且CS#被拉低时,连接到80X微处计,"自号。当该引数据读录操作开始。 选择串行或12 cf。	為。 与68XX系列微处, 用(E)信号。 当该 将启动读/写操作。 理器时,此引脚接收该 刺被拉低并且CS#被 更上,并且CS# 复式时,此引脚必须通	里器接口 制脚被拉 取(RD 低时, 接到VSS	Characteristics Diagrams. Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low. When serial or I²C mode is selected, this pin must be connected to V _{SS} .	

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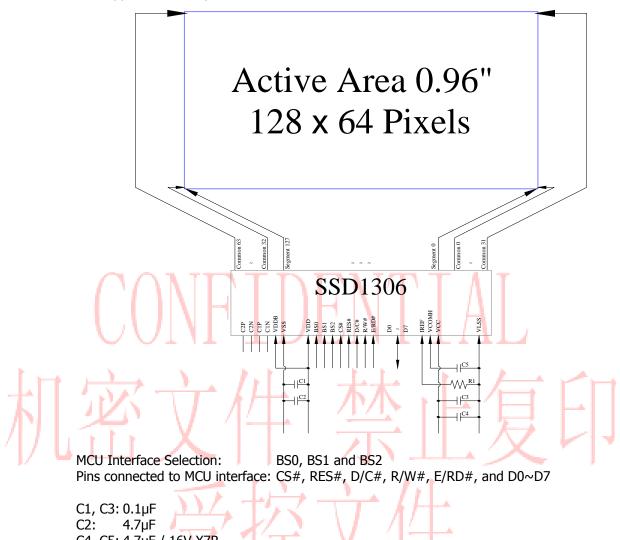
1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function
Interface (Co	ontinued)		
理器接口时 #) 选择输入 行读取模式。 16 当被子 (WR #) 输入 当该引脚 据写操作开始	養口輸入。 与68XX系3 此引脚将用作读/写(将其引脚拉至"高 將其引脚拉至"低"! (接口 尺≠W# 比引脚 拉低并且CS#被拉低 112 C模式时,此引脚	R / W " 以进 以进行 将为 军 时,数	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low. When serial or I²C mode is selected, this pin must be connected to V _{SS} .
这些引脚是8位双向数据器的数据总线。 选择串据输入SDIN、D0将为串行C4模式的,应将D2和D1象作SDAUTION系统,可D0分别的是10分别,可D2外到IVSS。	9.线,用于连接到微处 行模式时,D1将为串行时钟输入SCLK。选择 在一起,并在应用中 是串行时钟输入SCL。 未使 20 分	数 12 月	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I ² C mode is selected, D2 & D1 should be tired together and serve as SDA _{out} & SDA _{in} in application and D0 is the serial clock input SCL. Unused pins must be connected to V _{SS} except for D2 in serial mode.
Reserve			
7	N.C.	3	Reserved Pin The N.C. pin between function pins are reserved for compatible and flexible design.
1, 30	N.C. (GND)		Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground as the ESD protection circuit.

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1.6 Block Diagram

1.6.1 V_{CC} Supplied Externally



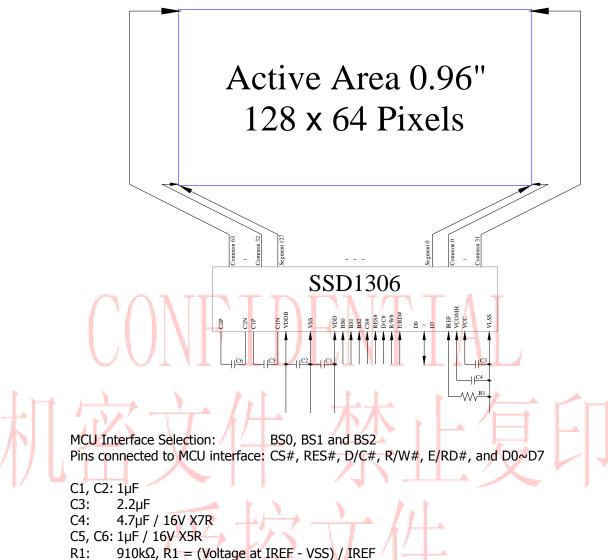
C4, C5: 4.7µF / 16V X7R

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

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1.6.2 V_{CC} Generated by Internal DC/DC Circuit



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2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	V_{DD}	-0.3	4	V	1, 2
Supply Voltage for Display	V _{CC}	0	16	V	1, 2
Supply Voltage for DC/DC	V _{BAT}	-0.3	5	V	1, 2
Operating Temperature	T _{OP}	-40	85	°C	
Storage Temperature	T _{STG}	-40	85	°C	3
Life Time (120 cd/m²)		10,000	-	hour	4
Life Time (80 cd/m²)		30,000	-	hour	4
Life Time (60 cd/m²)		50,000	-	hour	4

Note 1: All the above voltages are on the basis of " $V_{SS} = 0V$ ".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.

Note 4: $V_{CC} = 12.0V$, $T_a = 25$ °C, 50% Checkerboard.

Software configuration follows Section 4.4 Initialization.

End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.



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3. Optics & Electrical Characteristics

3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness (V _{CC} Supplied Externally)	L_{br}	Note 5	150	-	-	cd/m ²
Brightness (V _{CC} Generated by Internal DC/DC)	L _{br}	Note 6	150	180	-	cd/m²
C.I.E. (White)	(x) (y)	C.I.E. 1931	0.28 0.31	0.32 0.35	0.36 0.39	
Dark Room Contrast	CR		_	2000:1	-	
Viewing Angle			-	Free	_	degree

^{*} Optical measurement taken at V_{DD} = 2.8V, V_{CC} = 12V & 7.25V. Software configuration follows Section 4.4 Initialization.

3.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	V_{DD}		1.65	2.8	3.3	V
Supply Voltage for Display (Supplied Externally)	V _{CC}	Note 5 Note 5 (Internal DC/DC Disable)	11.5	12.0	12.5	V
Supply Voltage for DC/DC	$oldsymbol{V}_{\mathit{BAT}}$	Internal DC/DC Enable	<i>3.5</i>	<u>}-</u>	4.2	
Supply Voltage for Display (Generated by Internal DC/DC)	V _{CC}	Note 6 (Internal DC/DC Enable)	7.0	Æ	7.5	ν
High Level Input	V_{IH}	$I_{OUT} = 100 \mu A, 3.3 MHz$	$0.8 \times V_{DD}$	入	V_{DD}	V
Low Level Input	V_{IL}	$I_{OUT} = 100 \mu A, 3.3 MHz$	0	<u>/</u> ,X	$0.2 \times V_{DD}$	V
High Level Output	V _{OH}	$I_{OUT} = 100 \mu A, 3.3 MHz$	$0.9 \times V_{DD}$	-	V_{DD}	V
Low Level Output	V _{OL}	$I_{OUT} = 100 \mu A, 3.3 MHz$	0	-	$0.1 \times V_{DD}$	V
Operating Current for V _{DD}	I_{DD}	_X \/ / 4		180	300	μΑ
Operating Current for V _{CC} (V _{CC} Supplied Externally)	I_{CC}	Note 7	_	9	15	mA
Operating Current for V _{RAT} (V _{CC} Generated by Internal DC/DC)	$ extbf{\emph{I}}_{BAT}$	Note 8	-	25.6	32.0	mA
Sleep Mode Current for V _{DD}	$I_{\text{DD, SLEEP}}$		-	1	5	μΑ
Sleep Mode Current for V _{CC}	I _{CC, SLEEP}		-	2	10	μΑ

Note 5 & 6: Brightness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customer's request.

Note 7: $V_{DD} = 2.8V$, $V_{CC} = 12V$, 100% Display Area Turn on. Note 8: $V_{DD} = 2.8V$, $V_{CC} = 7.25V$, 100% Display Area Turn on.

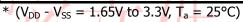
^{*} Software configuration follows Section 4.4 Initialization.

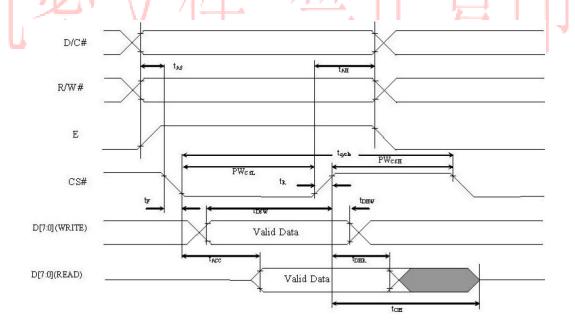
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3.3 AC Characteristics

3.3.1.1 68XX-Series MPU Parallel Interface Timing Characteristics:

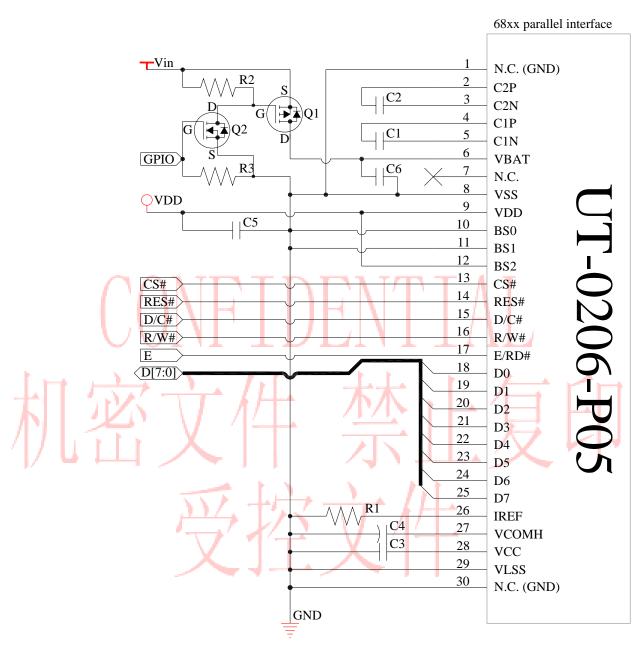
Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	300	-	ns
t _{AS}	Address Setup Time	5	-	ns
t _{AH}	Address Hold Time	0	-	ns
t _{DSW}	Write Data Setup Time	40	-	ns
t_DHW	Write Data Hold Time	7	-	ns
t_{DHR}	Read Data Hold Time	20	-	ns
t _{OH}	Output Disable Time	-	70	ns
t _{ACC}	Access Time	-	140	ns
DW	Chip Select Low Pulse Width (Read)	120		nc
PW _{CSL}	Chip Select Low Pulse width (Write)	60	-	ns
DVA	Chip Select High Pulse Width (Read)	60		20
PW _{CSH}	Chip Select High Pulse Width (Write)	60	_	ns
t _R	Rise Time		40	ns
t _F	Fall Time	J	40	ns





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3.3.1.2 **68XX-Series MPU Parallel Interface with Internal Charge Pump**



Recommended Components:

C1, C2: 1µF / 16V, X5R

C3: 2.2µF

C4: 4.7µF / 16V, X7R

C5, C6: 1µF

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

R2, R3: 47kΩ Q1: FDN338P Q2: FDN335N

Notes:

VDD: 1.65~3.3V, it should be equal to MPU I/O voltage.

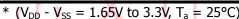
Vin: 3.5~4.2V

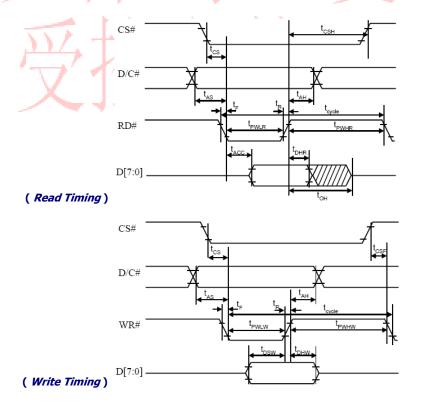
* VBAT will be connected to VDD when VCC be connected to external source (12V), R1 should be replaced as **910 k\Omega**.

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3.3.2.1 80XX-Series MPU Parallel Interface Timing Characteristics:

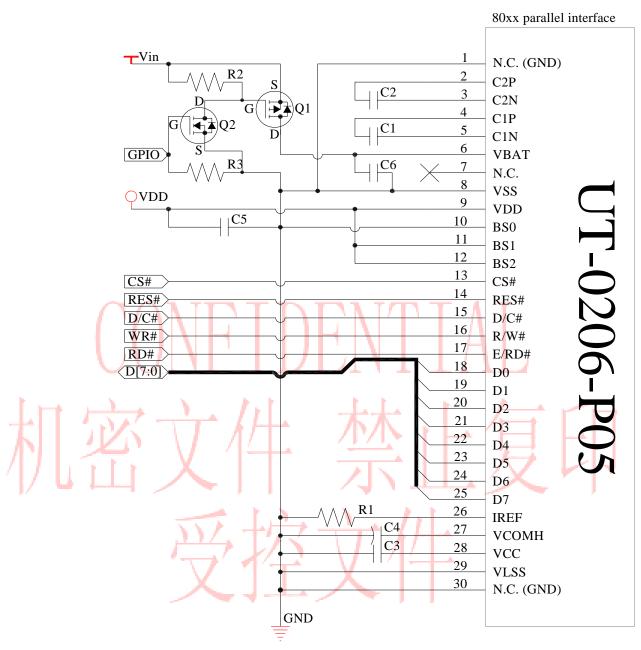
Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	300	-	ns
t _{AS}	Address Setup Time	10	_	ns
t _{AH}	Address Hold Time	0	-	ns
t _{DSW}	Write Data Setup Time	40	_	ns
t _{DHW}	Write Data Hold Time	7	-	ns
t _{DHR}	Read Data Hold Time	20	_	ns
t _{OH}	Output Disable Time	_	70	ns
t _{ACC}	Access Time	_	140	ns
t _{PWLR}	Read Low Time	120	_	ns
t _{PWLW}	Write Low Time	60	_	ns
t _{PWHR}	Read High Time	60	_	ns
t _{PWHW}	Write High Time	60	_	ns
t _{CS}	Chip Select Setup Time	0	_	ns
t _{CSH}	Chip Select Hold Time to Read Signal	10	-	ns
t _{CSF}	Chip Select Hold Time	20		ns
t _R	Rise Time	/ -	40	ns
t _F	Fall Time ————————————————————————————————————	<u>, </u>	40	ns





3.3.2.2 **80XX-Series MPU Parallel Interface with Internal Charge Pump**

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Recommended Components:

C1, C2: 1µF / 16V, X5R

C3: 2.2µF

C4: 4.7µF / 16V, X7R

C5, C6: 1µF

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

R2, R3: 47kΩ Q1: FDN338P Q2: FDN335N

Notes:

VDD: 1.65~3.3V, it should be equal to MPU I/O voltage.

Vin: 3.5~4.2V

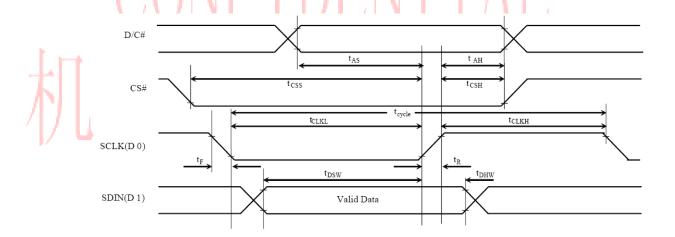
^{*} VBAT will be connected to VDD when VCC be connected to external source (12V), R1 should be replaced as **910 k\Omega**.

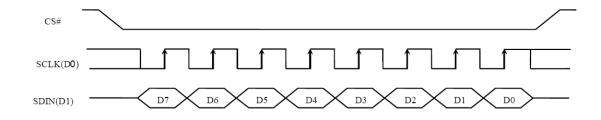
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3.3.3.1 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	100	-	ns
t _{AS}	Address Setup Time	15	-	ns
t _{AH}	Address Hold Time	15	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t _{CSH}	Chip Select Hold Time	10	-	ns
t _{DSW}	Write Data Setup Time	15	-	ns
t_DHW	Write Data Hold Time	15	-	ns
t _{CLKL}	Clock Low Time	20	-	ns
t _{CLKH}	Clock High Time	20	-	ns
t _R	Rise Time	-	40	ns
t _F	Fall Time	ιŤ	40	ns

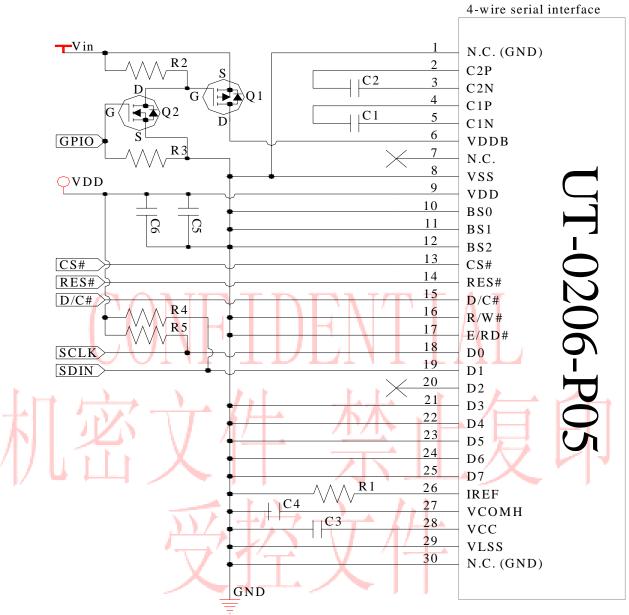
* $(V_{DD} - V_{SS} = 1.65V \text{ to } 3.3V, T_a = 25^{\circ}C)$





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3.3.3.2 **4-wire Serial Interface with Internal Charge Pump**



Recommended Components:

C1, C2: 1µF / 16V, X5R

C3: 2.2µF

C4: 4.7µF / 16V, X7R

C5, C6: 1µF

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

R2, R3: 47kΩR4, R5: 4.7kΩQ1: FDN338P Q2: FDN335N

Notes:

VDD: 1.65~3.3V, it should be equal to MPU I/O voltage.

Vin: 3.5~4.2V

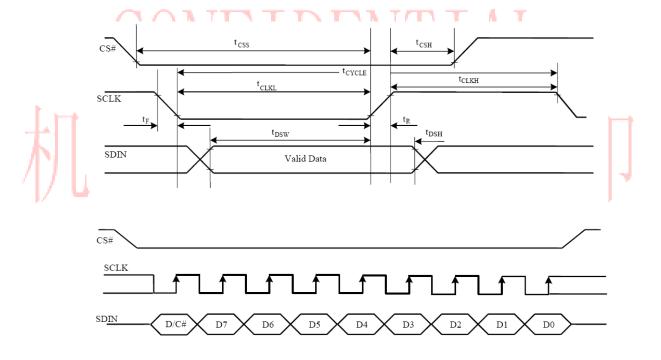
* VBAT will be connected to VDD when VCC be connected to external source (12V), R1 should be replaced as **910 kΩ**. ^{当VCC}连接到外部电源(12V)时,VBAT将连接到VDD,应将R1替换为910k。

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3.3.4.1 Serial Interface Timing Characteristics: (3-wire SPI)

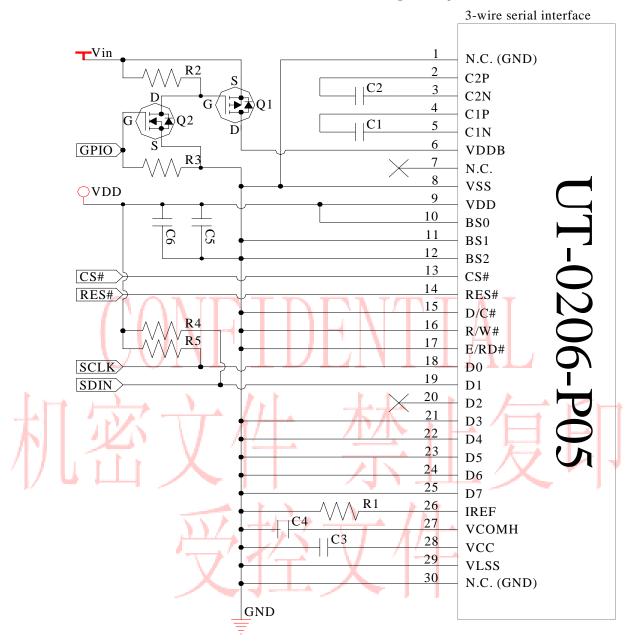
Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	100	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t _{CSH}	Chip Select Hold Time	10	-	ns
t _{DSW}	Write Data Setup Time	15	_	ns
t _{DHW}	Write Data Hold Time	15	_	ns
t _{CLKL}	Clock Low Time	20	_	ns
t _{CLKH}	Clock High Time	20	_	ns
t _R	Rise Time	_	40	ns
t _F	Fall Time	-	40	ns

^{*} $(V_{DD} - V_{SS} = 1.65V \text{ to } 3.3V, T_a = 25^{\circ}C)$



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3.3.4.2 **3-wire Serial Interface with Internal Charge Pump**



Recommended Components:

C1, C2: $1\mu F / 16V$, X5R C3: 2.2UF/16VC4: $4.7\mu F / 16V$, X7R

C5, C6: 1µF/16V

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

R2, R3: 47kΩR4, R5: 4.7kΩQ1: FDN338P Q2: FDN335N

Notes:

VDD: 1.65~3.3V, it should be equal to MPU I/O voltage.

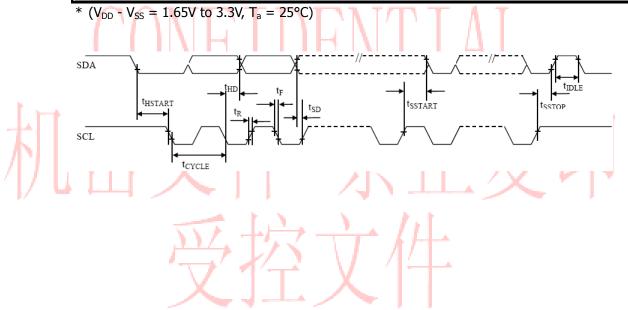
Vin: 3.5~4.2V

* VBAT will be connected to VDD when VCC be connected to external source (12V), R1 should be replaced as $910 \ k\Omega$.

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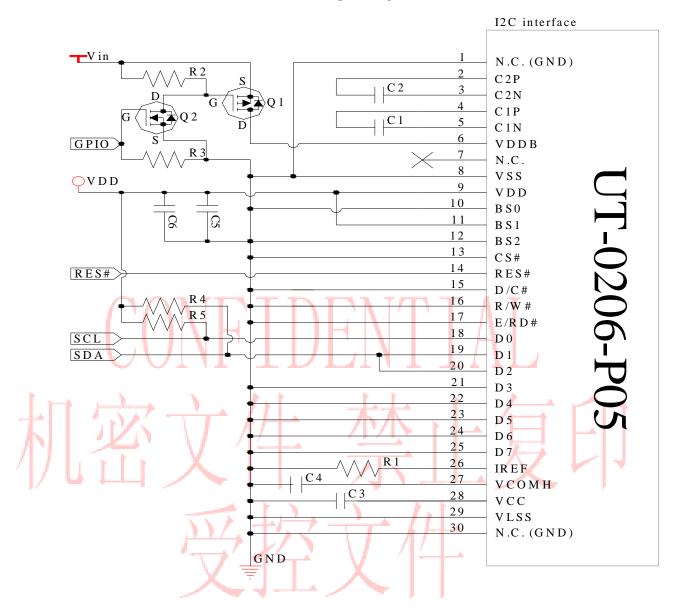
3.3.5.1 I²C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	2.5	-	μs
t _{HSTART}	Start Condition Hold Time	0.6	-	μs
	Data Hold Time (for "SDA _{OUT} " Pin)	0		
t _{HD}	Data Hold Time (for "SDA _{IN} " Pin)		_	ns
t _{SD}	Data Setup Time	100	_	ns
t _{SSTART}	Start Condition Setup Time (Only relevant for a repeated Start condition)		_	μs
t _{SSTOP} Stop Condition Setup Time		0.6	-	μs
t_R	t _R Rise Time for Data and Clock Pin		300	ns
t _F	Fall Time for Data and Clock Pin		300	ns
t _{IDLE}	Idle Time before a New Transmission can Start	1.3	_	μs



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3.3.5.2 I²C Interface with Internal Charge Pump



Recommended Components:

C1, C2: 1µF / 16V, X5R

C3: $2.2\mu F$

C4: 4.7µF / 16V, X7R

C5, C6: 1µF

R1: $910k\Omega$, R1 = (Voltage at IREF - VSS) / IREF

R2, R3: 47kΩR4, R5: 4.7kΩQ1: FDN338P Q2: FDN335N

Notes:

VDD: 1.65~3.3V, it should be equal to MPU I/O voltage.

Vin: 3.5~4.2V

The I^2C slave address is 0111100b'. If the customer ties D/C# (pin 15) to VDD, the I^2C slave address will be 0111101b'.

* VBAT will be connected to VDD when VCC be connected to external source (12V), R1 should be replaced as $\bf 910~k\Omega$.

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4. Functional Specification

4.1 Commands

Refer to the Technical Manual for the SSD1306

4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

 V_{CC}

V_{SS}/Ground

 V_{DD}

4.2.1 Power up Sequence:

- 1. Power up V_{DD} / V_{BAT}
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up V_{CC}
- 6. Delay 100ms (When V_{CC} is stable)
- 7. Send Display on command

4.2.2 Power down Sequence:

- 1. Send Display off command
- 2. Power down V_{CC} / V_{BAT}
- 3. Delay 100ms

(When V_{CC} / V_{BAT} is reach 0 and panel is completely discharges)

4. Power down V_{DD}

V_{CC}/V_{BAT} Off V_{CC}/V_{BAT} Off V_{DD} off V_{SS}/Ground

 V_{DD} on

V_{CC} /VBAT on

Display on

Note 13:

- 1) Since an ESD protection circuit is connected between V_{DD} and V_{CC} inside the driver IC, V_{CC} becomes lower than V_{DD} whenever V_{DD} is ON and V_{CC} is OFF.
- 2) V_{CC} / V_{BAT} should be kept float (disable) when it is OFF.
- 3) Power Pins $(V_{DD}, V_{CC}, V_{BAT})$ can never be pulled to ground under any circumstance.
- 4) V_{DD} should not be power down before V_{CC} / V_{BAT} power down.

4.3 Reset Circuit

When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 128×64 Display Mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 7Fh
- 9. Normal display mode (Equivalent to A4h command)

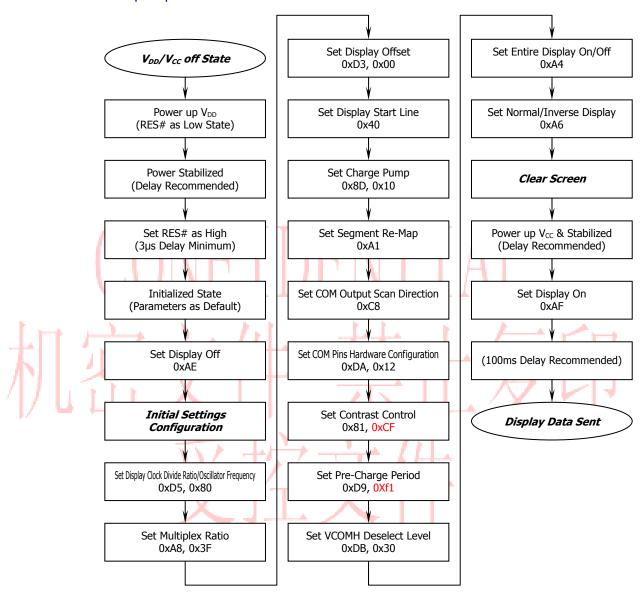
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4.4 Actual Application Example

Command usage and explanation of an actual example

4.4.1 V_{CC} Supplied Externally

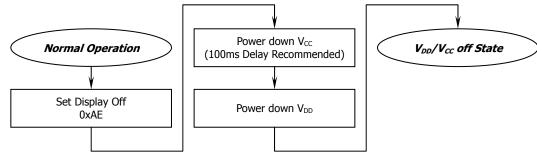
<Power up Sequence>



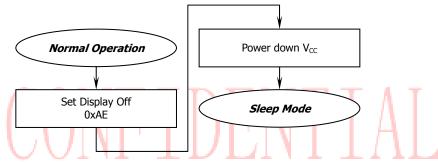
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

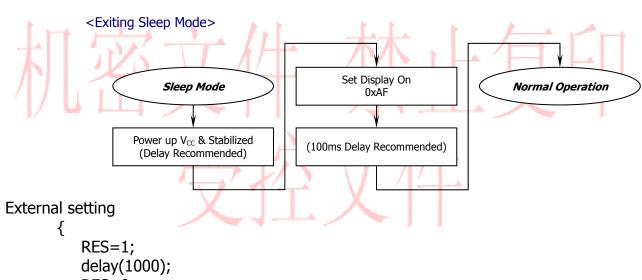
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<Power down Sequence>



<Entering Sleep Mode>





```
delay(1000);
RES=0;
delay(1000);
RES=1;
delay(1000);
write_i(0xAE);
/*display off*/
write_i(0x00);
/*set lower column address*/
write_i(0x10);
/*set higher column address*/
```

write_i(0x40); /*set display start line*/

write_i(0xB0); /*set page address*/

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```
write_i(0x81);
                          /*contract control*/
       write i(0xCF);
                          /*128*/
                          /*set segment remap*/
       write_i(0xA1);
       write_i(0xA6);
                          /*normal / reverse*/
       write_i(0xA8);
                          /*multiplex ratio*/
       write_i(0x3F);
                          /*duty = 1/64*/
       write_i(0xC8);
                          /*Com scan direction*/
       write_i(0xD3);
                          /*set display offset*/
       write i(0x00);
       write_i(0xD5);
                          /*set osc division*/
       write_i(0x80);
       write_i(0xD9);
                          /*set pre-charge period*,
       write_i(0Xf1);
       write_i(0xDA);
                          /*set COM pins*/
       write_i(0x12);
        write_i(0xdb);
                           /*set vcomh*/
        write_i(0x30);
       write_i(0x8d);
                           /*set charge pump disable*/
       write_i(0x10);
       write_i(0xAF);
                          /*display ON*/
void write_i(unsigned char ins)
   DC=0;
   CS=0;
   WR=1;
   P1=ins;
                   /*inst*/
   WR=0;
   WR=1;
   CS=1;
}
void write_d(unsigned char dat)
   DC=1;
```

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```
CS=0;
WR=1;
P1=dat; /*data*/
WR=0;
WR=1;
CS=1;
}

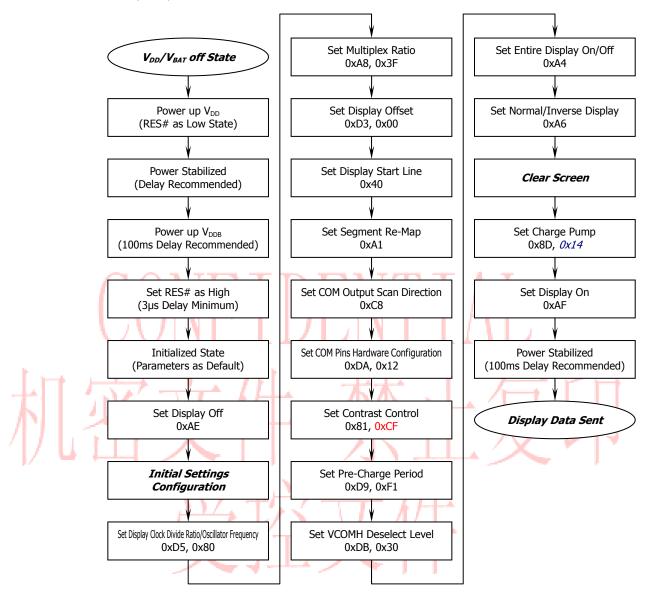
void delay(unsigned int i)
{
    while(i>0)
    {
    i--;
    }
}
```

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4.4.2 V_{CC} Generated by Internal DC/DC Circuit

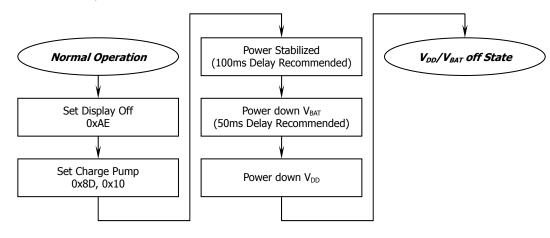
<Power up Sequence>



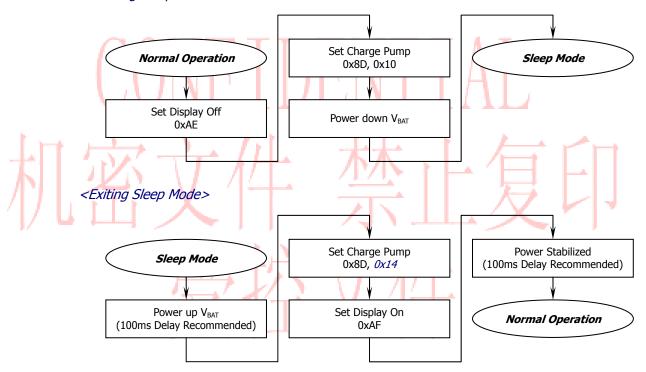
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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<Power down Sequence>



<Entering Sleep Mode>



```
Internal setting (Charge pump)

{
    RES=1;
    delay(1000);
    RES=0;
    delay(1000);
    RES=1;
    delay(1000);
    write_i(0xAE); /*display off*/

    write_i(0x00); /*set lower column address*/
    write_i(0x10); /*set higher column address*/
```

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```
/*set display start line*/
       write_i(0x40);
       write_i(0xB0);
                          /*set page address*/
       write_i(0x81);
                          /*contract control*/
       write_i(0xCF);
                          /*128*/
       write_i(0xA1);
                          /*set segment remap*/
       write i(0xA6);
                          /*normal / reverse*/
       write_i(0xA8);
                          /*multiplex ratio*/
       write_i(0x3F);
                          /*duty = 1/64*/
       write_i(0xC8);
                          /*Com scan direction*/
       write_i(0xD3);
                           /*set display offset*/
       write_i(0x00);
       write_i(0xD5);
                           /*set osc division*/
       write_i(0x80);
                           /*set pre-charge period*
        write_i(0xD9);
        write_i(0Xf1);
       write_i(0xDA);
                           /*set COM pins*/
       write_i(0x12);
       write_i(0xdb);
                           /*set vcomh*/
       write_i(0x30);
       write_i(0x8d);
                          /*set charge pump enable*/
       write_i(0x14);
                          /*display ON*/
       write_i(0xAF);
void write i(unsigned char ins)
   DC=0;
   CS=0;
   WR=1;
   P1=ins;
                   /*inst*/
   WR=0;
   WR=1;
   CS=1;
```

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```
}
void write_d(unsigned char dat)
   DC=1;
   CS=0;
   WR=1;
                 /*data*/
   P1=dat;
   WR=0;
   WR=1;
   CS=1;
}
void delay(unsigned int i)
{
    while(i>0)
}
```

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5. Reliability

5.1 Contents of Reliability Tests

Item	Conditions	Criteria	
High Temperature Operation	70°C, 240 hrs		
Low Temperature Operation	-40°C, 240 hrs		
High Temperature Storage	85°C, 240 hrs	The operational	
Low Temperature Storage	-40°C, 240 hrs	functions work.	
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs		
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell		

^{*} The samples used for the above tests do not include polarizer.
* No moisture condensation is observed during tests.

5.2 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.



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6. Outgoing Quality Control Specifications

6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature: 23 ± 5 °C Humidity: 55 ± 15 % RH

Fluorescent Lamp: 30W Distance between the Panel & Lamp: \geq 50cm Distance between the Panel & Eyes of the Inspector: \geq 30cm Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

6.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

6.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition	
Major	0.65	Defects in Pattern Check (Display On)	
Minor	1.0	Defects in Cosmetic Check (Display Off)	

6.3.1 Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
山人口	1	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)
Panel General Chipping	Minor	X
		X X X X X X X X X X X X X X X X X X X

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6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

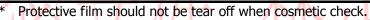
	Check Item	Classification	Criteria
	Panel Crack	Minor	Any crack is not allowable.
	Copper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
	Film or Trace Damage	Minor	
机	Terminal Lead Prober Mark	Acceptable	
	严步	77	
	Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
	Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

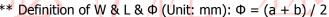
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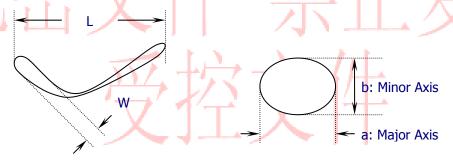
6.3.2 Cosmetic Check (Display Off) in Active Area

It is recommended to execute in clear room environment (class 10k) if actual in necessary.

Check Item	Classification	Criteria
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affect the Polarizer
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W \le 0.1$ Ignore $W > 0.1$ $L \le 2$ $n \le 1$ $L > 2$ $n = 0$
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$\Phi \le 0.1$ Ignore $0.1 < \Phi \le 0.25$ $n \le 1$ $0.25 < \Phi$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	Φ ≤ 0.5 → Ignore if no Influence on Display $0.5 < Φ$ $n = 0$
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable







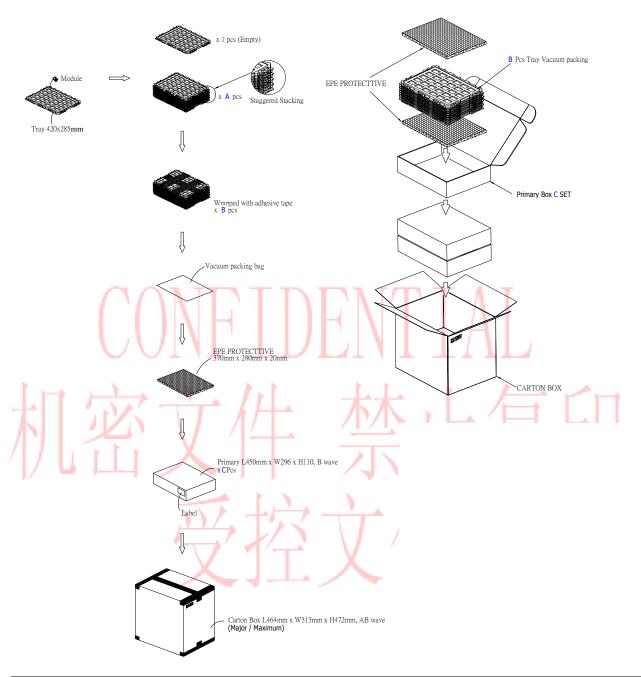
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6.3.3 Pattern Check (Display On) in Active Area

	Check Item	Classification	Criteria
	No Display	Major	
	Missing Line	Major	
	Pixel Short	Major	,
机	密文件	力	
	Darker Pixel	Major	
	Wrong Display	Major	
	Un-uniform	Major	

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7. Package Specifications



Item			Quantity
Module		810	per Primary Box
Holding Trays	(A)	15	per Primary Box
Total Trays	(B)	16	per Primary Box (Including 1 Empty Tray)
Primary Box	(C)	1~4	per Carton (4 as Major / Maximum)

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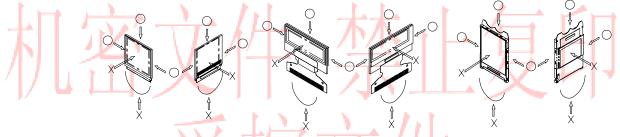
8. Precautions When Using These OEL Display Modules

8.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the driver IC and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OEL display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

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8.2 Storage Precautions

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Allvision technology Inc.) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

8.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the $V_{\rm IL}$ and $V_{\rm IH}$ specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1306

 * Connection (contact) to any other potential than the above may lead to rupture of the IC.

8.4 Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

8.5 Other Precautions

- 1) When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
 - Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the FPC
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
 - * Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
 - * Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may

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be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

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Warranty:

The warranty period shall last twelve (12) months from the date of delivery. Buyer shall be completed to assemble all the processes within the effective twelve (12) months. WiseChip Semiconductor Inc. shall be liable for replacing any products which contain defective material or process which do not conform to the product specification, applicable drawings and specifications during the warranty period. All products must be preserved, handled and appearance to permit efficient handling during warranty period. The warranty coverage would be exclusive while the returned goods are out of the terms above.

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